

XTR106 4mA-to-20mA Current Transmitter With Bridge Excitation and Linearization

1 Features

- Low total unadjusted error
- 2.5V, 5V bridge excitation references
- 5.1V regulator output
- Low span drift: ±25ppm/°C maximum
- Low offset drift: 0.25µV/°C
- High PSR: 110dB minimum
- High CMR: 86dB minimum
- Wide supply range: 7.5V to 36V
- 14-pin DIP and SOIC package options

2 Applications

- Field transmitter and sensor
- Factory automation
- Compatible with HART modem
- Pressure and temperature bridge transmitters
- Industrial process control
- SCADA remote data acquisition
- Weighing systems
- Strain gauge transmitters
- Accelerometers

3 Description

The XTR106 is a monolithic 4mA to 20mA, twowire current transmitter designed for cost-optimized bridge sensor applications. This device provides complete bridge excitation (2.5V or 5V reference), instrumentation amplifier, sensor linearization, and current output circuitry. Current for powering additional external input circuitry is available from the V_{REG} pin.

The instrumentation amplifier can be used over a wide range of gain, accommodating a variety of input signal types and sensors. Total unadjusted error of the complete current transmitter, including the linearized bridge, is low enough to permit use without adjustment in many applications. The XTR106 operates on loop power supply voltages down to 7.5V.

Linearization circuitry provides second-order correction to the transfer function by controlling bridge excitation voltage. The device provides up to a 20:1 improvement in nonlinearity, even with cost-optimized transducers.

The XTR106 is available in 14-pin plastic DIP and 14pin SOIC surface-mount packages, and is specified for the -40° C to $+85^{\circ}$ C temperature range. The device operates from -40° C to $+125^{\circ}$ C.

Package	Information
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PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾
YTP106	D (SOIC, 14)	8.65mm × 6mm
XIR106	N (PDIP, 14)	19.3mm × 9.4mm

(1) For all available packages, see Section 10.

(2) The package size (length × width) is a nominal value and includes pins, where applicable.



XTR106 Bridge Nonlinearity Correction



Bridge Nonlinearity Correction Schematic Using the XTR106



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4 Pin Configuration and Functions





PIN		TYPE	DESCRIPTION
NAME	NO.		DESCRIPTION
B (Base)	9	Output	Base connection for external transistor
E (Emitter)	8	Input	Emitter connection for external transistor
I _O	7	Output	Regulated 4mA to 20mA current loop output
I _{RET}	6	Input	Local ground return pin for V_{REG} , $V_{REF}5$, and $V_{REF}2.5$
Lin Polarity	12	Input	Linearity correction circuit polarity setting. Connect to I_{RET} to correct for positive nonlinearity, or connect to V_{REG} to correct for negative nonlinearity or if not using the linearity correction feature
R _G	3, 4	_	Input stage gain setting pins. The resistance R_G between pins 3 and 4 sets the gain of the voltage-to-current transfer function
R _{LIN}	11	_	Linearity correction resistor pin. The resistance R _{LIN} between pins 1 and 11 sets the corrective factor of the linearity correction circuit
V+	10	Power	Loop power supply
V _{IN-}	2	Input	Negative (inverting) differential voltage input
V _{IN+}	5	Input	Positive (noninverting) differential voltage input
V _{REF} 5	14	Output	5V reference voltage output
V _{REF} 2.5	13	Output	2.5V reference voltage output
V _{REG}	1	Output	5.1V regulator voltage output

Table 4-1. Pin Functions



5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

		MIN	MAX	UNIT
V+	Power supply (referenced to IO pin)		40	V
	Input voltage, V_{IN+} or V_{IN-} (referenced to IRET pin)	0	V+	V
	Output current limit		Continuous	
T _A	Operating temperature	-40	125	°C
TJ	Junction temperature		165	°C
T _{stg}	Storage temperature	-55	125	°C
	Lead temperature (soldering, 10s)		300	°C

(1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime

5.2 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V+	Power supply (referenced to the I _O pin)	7.5	24	36	V
T _A	Specified temperature	-40		85	°C

5.3 Thermal Information

		XT	XTR106		
	THERMAL METRICS ⁽¹⁾	D (SOIC)	N (PDIP)	UNIT	
		14	PINS		
R _{θJA}	Junction-to-ambient thermal resistance	86.8	51.8	°C/W	
R _{0JC(top)}	Junction-to-case (top) thermal resistance	46.9	29.4	°C/W	
$R_{\theta JB}$	Junction-to-board thermal resistance	46.0	24.2	°C/W	
Ψյτ	Junction-to-top characterization parameter	9.6	7.8	°C/W	
Ψ _{JB}	Junction-to-board characterization parameter	45.6	23.7	°C/W	
R _{0JC(bot)}	Junction-to-case (bottom) thermal resistance	N/A	N/A	°C/W	

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC package thermal metrics application note.



5.4 Electrical Characteristics

	PARAMETER	TEST C	ONDITIONS	MIN	TYP	MAX	UNITS	
OUTPUT								
Io	Output current equation				$I_O = V_{IN} \cdot (40/R_G) + 4mA, V_{in} in V_{R_G} in \Omega$		/ _{in} in Volts,	А
	Output current, specified range			4		20	mA	
I _{OVER}	Overscale limit			24	28	30	mA	
	Linderseele limit	$I_{REG} = 0, I_{REF} = 0$		1	1.6	2.2		
UNDER		I _{REF} + I _{REG} = 2.5mA		2.9	3.4	4	IIIA	
ZERO O	UTPUT ⁽¹⁾ (V _{IN} = 0V, R _G = ∞)							
I _{ZERO}	Zero output				4		mA	
	Initial error	XTR106P, XTR106U			±5	±25		
		XTR106PA, XTR106UA			±5	±50	μΑ	
	vs temperature	$T_A = -40^{\circ}C$ to $+85^{\circ}C$			±0.07	±0.9	µA/°C	
	vs supply voltage, V+	V+ = 7.5V to 36V			0.04	0.2	μA/V	
	vs common-mode voltage (CMRR)	V_{CM} = 1.1V to 3.5V ⁽⁵⁾			0.02		μA/V	
	vs V _{REG} (I _O)				0.8		µA/mA	
i _n	Noise: 0.1Hz to 10Hz				0.035		μАр-р	
SPAN								
S	Span equation (transconductance)				$S = 40/R_G$		A/V	
	Lintrimmed error	rimmed error Full scale (V_{IN}) = 50mV	XTR106P, XTR106U		±0.05	±0.2	0/2	
			XTR106PA, XTR106UA		±0.05	±0.4	70	
	vs temperature ⁽²⁾	$T_A = -40^{\circ}C$ to $+85^{\circ}C$			±3	±25	ppm/°C	
	Nonlinearity: ideal input ⁽³⁾	Full scale (V_{IN}) = 50mV			±0.001	±0.01	%	
INPUT ⁽⁴⁾								
Vaa	Offset voltage	V _{CM} = 2.5V	XTR106P, XTR106U		±50	±100	μV	
VOS			XTR106PA, XTR106UA		±50	±250		
	vs temperature $T_A = -40^{\circ}C$ to +85°C	$T_{1} = -40^{\circ}$ C to +85°C	XTR106P, XTR106U		±0.25	±1.5	μV/°C	
		$T_{A} = -40 \text{ C to +65 C}$	XTR106PA, XTR106UA		±0.25	±3		
	vs supply voltage, V+	V+ = 7.5V to 36V			±0.1	±3	μV/V	
CMRR	vs.common-mode voltage RTI	$V_{\rm ev} = 1.1 V_{\rm to} 3.5 V_{\rm c}^{(5)}$	XTR106P, XTR106U		±10	±50		
CIVILAT	vs common-mode voltage, RTI	VCM = 1.1V to 3.3V	XTR106PA, XTR106UA		±10	±100	μν/ν	
V _{CM}	Common-mode range ⁽⁵⁾			1.1		3.5	V	
1-	Input bias current	XTR106P, XTR106U	XTR106P, XTR106U		5	25	nA	
в		XTR106PA, XTR106UA	XTR106PA, XTR106UA		5	50		
	vs temperature	$T_A = -40^{\circ}C$ to $+85^{\circ}C$			20		pA/°C	
laa	Input offset current	XTR106P, XTR106U			±0.2	±3	nΔ	
os	input onset current	XTR106PA, XTR106UA			±0.2	±10		
	vs temperature	$T_A = -40^{\circ}C$ to $+85^{\circ}C$			5		pA/°C	
Z _{IN}	Impedance: differential				0.1 1		GΩ ∥ pF	
	Common-mode				5 10		GΩ ∥ pF	
V _n	Noise: 0.1Hz to 10Hz				0.6		µVp-p	



5.4 Electrical Characteristics (continued)

at T_A = +25°C, V+ = 24V, and TIP29C external transistor (unless otherwise noted)

	PARAMETER	PARAMETER TEST CONDITIONS MIN TYP MAX		UNITS				
VOLTAGE REFERENCES ⁽⁵⁾ (Lin Polarity Connected to V _{REG} , R _{LIN} = 0)								
V _{REF} 2.5	Initial: 2.5V reference			2	2.5	V		
V _{REF} 5	5V reference				5	V		
	A	$\gamma = 2 E \gamma er E \gamma$	XTR106P, XTR106U	±0.	05 ±0.25	0/		
	Accuracy	V _{REF} = 2.5V 0I 5V	XTR106PA, XTR106UA	±0.	05 ±0.5	70		
	ve temperature ⁽⁶⁾	T 40°C to +95°C	XTR106P, XTR106U	±	20 ±35	nnm/°C		
		$I_A = -40 \text{ C to +65 C}$	XTR106PA, XTR106UA	±	20 ±75	ppm/ C		
	vs supply voltage, V+	V+ = 7.5V to 36V			±5 ±20	ppm/V		
	vs load	I _{REF} = 0mA to 2.5mA			60	ppm/mA		
	Noise: 0.1Hz to 10Hz				10	µVp-p		
V _{REG} ⁽⁵⁾								
	V _{REG}			Ę	5.1	V		
	Accuracy			±0.	02 ±0.1	V		
	vs temperature	T _A = −40°C to +85°C	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$).5	mV/°C		
	vs supply voltage, V+	V+ = 7.5V to 36V			1	mV/V		
I _{REG}	Output current			See Typical C	urves	mA		
	Output impedance	I _{REG} = 0mA to 2.5mA			80	Ω		
LINEARI	ZATION ⁽⁷⁾							
R _{LIN}	R _{LIN} (external) equation			RLIN = KLIN • (4B/(1-2 is nonlinearity rela	B)), K _{LIN} in Ω, B tive to V _{FS}	Ω		
K	K linearization factor	V _{REF} = 5V		6.6	45	kΩ		
N LIN		V _{REF} = 2.5V		9.9	05	kΩ		
	Accuracy				±1 ±5	%		
	vs Temperature	$T_{A} = -40^{\circ}C \text{ to } +85^{\circ}C \qquad \qquad \pm 50 \qquad \pm 70^{\circ}C$		50 ±100	ppm/°C			
P	Maximum correctable sensor	V _{REF} = 5V			±5	$\%$ of V_{FS}		
в	nonlinearity	V _{REF} = 2.5V		-2.5,	+5	% of V_{FS}		

(1) Describes accuracy of the 4mA low-scale offset current. Does not include input amplifier effects. Can be trimmed to zero.

Does not include initial error or TCR of gain-setting resistor, R_G. (2)

Increasing the full-scale input range improves nonlinearity. (3)

Does not include zero output initial error.

(4) (5)

Voltage measured with respect to I_{RET} pin. Calculated using the box method: (MAX_(-40°C to 85°C) – MIN_(-40°C to 85°C)) / MIN_(-40°C to 85°C) / (85°C – (-40°C)). See also Section 6.3.1. V_{FS} = full-scale V_{IN}. (6)

(7)



5.5 Typical Characteristics





5.5 Typical Characteristics (continued)





5.5 Typical Characteristics (continued)





5.5 Typical Characteristics (continued)





6 Detailed Description

6.1 Overview

The XTR106 is a monolithic 4mA-to-20mA, 2-wire current transmitter with a differential voltage input. Figure 6-1 shows the simplified schematic of the XTR106. The loop power supply, V+, provides power for all circuitry. The output loop current is modulated by the XTR106 and is typically measured as a voltage across a series load resistor (R_L).

The instrumentation amplifier input of the XTR106 measures the voltage difference between the noninverting and inverting inputs. This difference is then gained up according to the value of R_G , and expressed as a regulated current output.







6.2 Functional Block Diagram



6.3 Feature Description

6.3.1 Linearization

Many bridge sensors are inherently nonlinear. With the addition of one external resistor, compensating for parabolic nonlinearity with up to a 20:1 improvement over an uncompensated bridge output is possible.

Linearity correction is accomplished by varying the bridge excitation voltage. Signal-dependent variation of the bridge excitation voltage adds a second-order term to the overall transfer function (including the bridge). This configuration can be tailored to correct for bridge sensor nonlinearity.

Either positive or negative bridge nonlinearity errors can be compensated by proper connection of the Lin Polarity pin. To correct for positive bridge nonlinearity (upward bowing), connect Lin Polarity (pin 12) to I_{RET} (pin 6); see also Figure 6-2. This correction causes V_{REF} to increase with bridge output, which compensates for a positive bow in the bridge response. To correct negative nonlinearity (downward bowing), connect Lin Polarity to V_{REG} (pin 1); see also Figure 6-3. This correction causes V_{REF} to decrease with bridge output. The Lin Polarity pin is a high-impedance node.



Figure 6-2. Connection for Positive Bridge Nonlinearity, V_{REF} = 5V





Figure 6-3. Connection for Negative Bridge Nonlinearity, V_{REF} = 2.5V

If no linearity correction is desired, connect both the R_{LIN} and Lin Polarity pins to V_{REG} (see also Figure 6-4). This connection results in a constant reference voltage independent of input signal.

Note Do not leave the R_{LIN} or Lin Polarity pins open or connected to another potential.



Figure 6-4. Connection if No Linearity Correction is Desired, V_{REF} = 5V

 R_{LIN} is the external linearization resistor and is connected between pin 11 and pin 1 (V_{REG}); see also Figure 6-2 and Figure 6-3. To determine the value of R_{LIN} , the nonlinearity of the bridge sensor with constant excitation voltage must be known. The XTR106 linearity circuitry can only compensate for the parabolic-shaped portions of a sensor nonlinearity. Optimized correction occurs when maximum deviation from linear output occurs at midscale (see Figure 7-3 and Figure 7-4). Sensors with nonlinearity curves similar to that shown in Figure 7-3 and Figure 7-4, but not peaking exactly at midscale can be substantially improved.



(1)

A sensor with an S-shaped nonlinearity curve (equal positive and negative nonlinearity) cannot be improved with the XTR106 correction circuitry. The value of R_{LIN} is chosen according to Equation 1. R_{LIN} depends on a linearization factor, K_{LIN} , which differs for the 2.5V reference and 5V reference. The sensor nonlinearity term, B (relative to full scale), is positive or negative depending on the direction of the bow.

Linearization resistor:

$$R_{LIN} = |K_{LIN} \times \frac{4B}{1-2B}|$$

where:

- K_{LIN} is the linearization factor (in Ω)
- K_{LIN} is 9905 Ω for the 2.5V reference
- K_{LIN} is 6645 Ω for the 5V reference
- B is the sensor nonlinearity relative to V_{FS} (for -2.5% nonlinearity, B = -0.025)
- V_{FS} is the full-scale bridge output without linearization (in V)

A maximum $\pm 5\%$ nonlinearity can be corrected when the 5V reference is used. Sensor nonlinearity of $\pm 5\%/-2.5\%$ can be corrected with 2.5V excitation. The trim circuit shown in Figure 6-5 can be used for bridges with unknown bridge nonlinearity polarity.



Figure 6-5. Onboard Resistor Circuit for Unknown Bridge Nonlinearity Polarity

Gain is affected by the varying excitation voltage used to correct bridge nonlinearity. The corrected value of the gain resistor is calculated from Equation 2.

Gain-set resistor:

$$R_{G} = \frac{V_{FS}}{400\mu A} \times \frac{1+2B}{1-2B}$$

where:

• V_{FS} is the full-scale bridge output without linearization (in V)

When using linearity correction, keep the sensor output common-mode voltage within the XTR106 allowable input range of 1.1V to 3.5V. Equation 3 can be used to calculate the XTR106 new excitation voltage. The common-mode voltage of the bridge output is simply half this value if no common-mode resistor is used (see also the examples in Figure 6-2 and Figure 6-3). Exceeding the common-mode range can yield unpredictable results.

Adjusted excitation voltage at full-scale output:

$$V_{\text{REF (Adj)}} = V_{\text{REF (Initial)}} \times \frac{1+2B}{1-2B}$$

(3)

(2)



For high-precision applications (errors < 1%), a two-step calibration process can be employed. First, the nonlinearity of the sensor bridge is measured with the initial gain resistor and $R_{LIN} = 0$ (R_{LIN} pin connected directly to V_{REG}). Using the resulting sensor nonlinearity, B, values for R_G and R_{LIN} are calculated using Equation 1 and Equation 2. A second calibration measurement is then taken to adjust R_G to account for the offsets and mismatches in the linearization.

Example:

Calculate R_{LIN} and the resulting R_{G} for a bridge sensor with 2.5% downward bow nonlinearity relative to V_{FS} and determine if the input common-mode range is valid.

For
$$V_{REF}$$
 = 2.5V and V_{FS} = 50mV

For a 2.5% downward bow, B = -0.025 (Lin Polarity pin connected to V_{REG})

For V_{REF} = 2.5V, K_{LIN} = 9905 Ω

$$R_{\text{LIN}} = \left| \frac{(9905\Omega)(4)(-0.025)}{1 - (2)(-0.025)} \right| = 943\Omega$$
(4)

$$R_{\rm G} = \frac{0.05V}{400\mu\rm{A}} \times \frac{1 + (2)(-0.025)}{1 - (2)(-0.025)} = 113\Omega$$
(5)

$$V_{CM} = \frac{V_{REF} (Adj)}{2} = \frac{1}{2} \times 2.5V \times \frac{1 + (2)(-0.025)}{1 - (2)(-0.025)} = 1.13V$$
(6)

which falls within the 1.1V to 3.5V input common-mode range.

6.3.2 Reverse-Voltage Protection

The XTR106 low compliance rating (7.5V) permits the use of various voltage protection methods without compromising operating range. Figure 6-6 shows a diode bridge circuit which allows normal operation even when the voltage connection lines are reversed. The bridge causes a two diode drop (approximately 1.4V) loss in loop-supply voltage. This results in a compliance voltage of approximately 9V—satisfactory for most applications. If a 1.4V drop in loop supply is too much, a diode can be inserted in series with the loop supply voltage and the V+ pin, as shown in Figure 7-6. This protects against reverse output connection lines with only a 0.7V loss in loop-supply voltage.



(1) 36V Zener diode, such as 1N4753A or P6KE39A. Use lower-voltage Zener diodes with loop power-supply voltages < 30V for increased protection.

Figure 6-6. Reverse-Voltage Operation and Overvoltage Surge Protection



6.3.3 Overvoltage Surge Protection

Remote connections to current transmitters are sometimes subjected to voltage surges. Limit the maximum surge voltage applied to the XTR106 to the lowest practical value. Various Zener diode and surge clamping diodes are specially designed for this purpose. Select a clamp diode with as low a voltage rating as possible for best protection. For example, a 36V protection diode maintains proper transmitter operation at normal loop voltages, yet provides an appropriate level of protection against voltage surges. The XTR106 is specified to an absolute maximum loop voltage of 40V.

Most surge protection Zener diodes have a diode characteristic in the forward direction that conducts excessive current, possibly damaging receiving-side circuitry, if the loop connections are reversed. If a surge protection diode is used, use a series diode or diode bridge for protection against reversed connections.

6.4 Device Functional Modes

The device has one mode of operation that applies when operated within the *Recommended Operating Conditions*.



7 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

7.1 Application Information

Figure 7-1 shows the basic connection diagram for the XTR106. The loop power supply, V_{PS} , provides power for all circuitry. Output loop current is measured as a voltage across the series load resistor, R_L . A 0.01µF to 0.03µF supply bypass capacitor connected between V+ and I_O is recommended. For applications where fault, overload conditions, or both can saturate the inputs, a 0.03µF capacitor is recommended.

A 2.5V or 5V reference is available to excite a bridge sensor. For 5V excitation, connect pin 14 (V_{REF} 5) to the bridge; see also Figure 7-1. For 2.5V excitation, connect pin 13 (V_{REF} 2.5) to pin 14; see also Figure 6-3. The output terminals of the bridge are connected to the instrumentation amplifier inputs, V_{IN+} and V_{IN-} . A 0.01µF capacitor is shown connected between the inputs and is recommended for high impedance bridges (> 10k Ω). The resistor R_G sets the gain of the instrumentation amplifier as required by the full-scale bridge voltage, V_{FS} .

Lin Polarity and R_{LIN} provide second-order linearization correction to the bridge, achieving up to a 20:1 improvement in linearity. Connections to Lin Polarity (pin 12) determine the polarity of nonlinearity correction; connect either to I_{RET} or V_{REG}. Connect Lin Polarity to V_{REG} even if linearity correction is not desired. R_{LIN} is chosen according to Equation 7 and depends on K_{LIN} (linearization constant) and the bridge nonlinearity relative to V_{FS} (see Section 6.3.1).

$$R_{\text{LIN}} = \left| K_{\text{LIN}} \times \frac{4B}{1 - 2B} \right| \tag{7}$$

where:

• K_{LIN} is in Ω

$$R_{G} = \left(\frac{V_{FS}}{400\mu A}\right) \times \frac{1+2B}{1-2B}$$

$$\tag{8}$$

where:

- V_{FS} is in V
- $K_{LIN} = 9.905 k\Omega$ for 2.5V reference
- $K_{LIN} = 6.645 k\Omega$ for 5V reference
- B is the bridge nonlinearity relative to V_{FS}
- V_{FS} is the full-scale input voltage

The transfer function for the complete current transmitter is:

$$I_0 = 4mA + V_{IN} \times \left(\frac{40}{R_G}\right) \tag{9}$$

Where:

- V_{IN} V_{IN} is the differential input voltage in Volts
- R_G is in Ohms

As evident from the transfer function, if no R_G is used ($R_G = \infty$), the gain is zero and the output is simply the XTR106 zero current.



A negative input voltage, V_{IN} , causes the output current to be less than 4mA. Increasingly negative V_{IN} causes the output current to limit at approximately 1.6mA. If current is being sourced from the reference and/or V_{REG} , the current limit value can increase. See also Figure 5-7 and Figure 5-8.

Increasingly positive input voltage (greater than the full-scale input, V_{FS}) produces increasing output current according to the transfer function, up to the output current limit of approximately 28mA. See also Figure 5-9.

The I_{RET} pin is the return path for all current from the references and V_{REG} . I_{RET} also serves as a local ground and is the reference point for V_{REG} and the onboard voltage references. The I_{RET} pin allows any current used in external circuitry to be sensed by the XTR106 and to be included in the output current without causing error. The input voltage range of the XTR106 is referred to this pin.



(1) Connect Lin Polarity (pin 12) to I_{RET} (pin 6) to correct for positive bridge nonlinearity or connect to V_{REG} (pin 1) for negative bridge nonlinearity. The R_{LIN} pin and Lin Polarity pin must be connected to V_{REG} if linearity correction is not desired. Refer to the *Linerization* section.

(2) Recommended for bridge impedances > $10k\Omega$.

(3) R₁ and R₂ form bridge trim circuit to compensate for the initial accuracy of the bridge. See the *Bridge Balance* text.

Figure 7-1. Basic Bridge Measurement Circuit With Linearization



7.1.1 External Transistor

External pass transistor, Q₁, conducts the majority of the signal-dependent 4mA-to-20mA loop current. Using an external transistor isolates the majority of the power dissipation from the precision input and reference circuitry of the XTR106, maintaining excellent accuracy.

The external transistor is inside a feedback loop; therefore, the characteristics are not critical. Requirements are: $V_{CEO} = 45V$ min, $\beta = 40$ min and $P_D = 800$ mW. Power dissipation requirements can be lower if the loop power supply voltage is less than 36V. Some possible choices for Q_1 are listed in Figure 7-1. The XTR106 can be operated without an external pass transistor. Accuracy, however, is somewhat degraded as a result of the internal power dissipation and subsequent self-heating. Operation without Q_1 is not recommended for extended temperature ranges. A resistor (R = 3.3k Ω) connected between the I_{RET} pin and the E (emitter) pin is advised for operation less than 0°C without Q_1 to maintain the full 20mA full-scale output, especially with V+ near 7.5V.



(1) For operation without external transistor, connect a $3.3k\Omega$ resistor between pin 6 and pin 8. See text for discussion of performance.

Figure 7-2. Operation Without an External Transistor

7.1.2 Loop Power Supply

The voltage applied to the XTR106, V+, is measured with respect to the I_O connection, pin 7. V+ can range from 7.5V to 36V. The loop-supply voltage, V_{PS}, differs from the voltage applied to the XTR106 according to the voltage drop on the current sensing resistor, R_L (plus any other voltage drop in the line).

If a low loop-supply voltage is used, R_L (including the loop wiring resistance) must be made a relatively low value so that V+ remains 7.5V or greater for the maximum loop current of 20mA:

$$R_{L MAX} = \left(\frac{(V+)-7.5V}{20mA}\right) - R_{WIRING}$$
(10)

For loop currents up to 30mA, design for V+ equal or greater than 7.5V to allow for out-of-range input conditions. V+ must be at least 8V if 5V sensor excitation is used and if correcting for bridge nonlinearity greater than +3%.

The low operating voltage (7.5V) of the XTR106 allows operation directly from personal computer power supplies (12V \pm 5%). When used with the RCV420 Current Loop Receiver (Figure 7-6), load resistor voltage drop is limited to 3V.



7.1.3 Bridge Balance

Figure 7-1 shows a bridge trim circuit (R_1 , R_2). This adjustment can be used to compensate for the initial accuracy of the bridge, to trim the offset voltage of the XTR106, or both. The values of R_1 and R_2 depend on the impedance of the bridge, and the trim range required. This trim circuit places an additional load on the V_{REF} output. Be sure the additional load on V_{REF} does not affect zero output. See Figure 5-8. The effective load of the trim circuit is nearly equal to R_2 . An approximate value for R_1 can be calculated:

$$R_1 \approx \frac{5V \times R_B}{4 \times V_{\text{TRIM}}} \tag{11}$$

Where:

- R_B is the resistance of the bridge
- V_{TRIM} is the desired ±voltage trim range (in V)

Make R_2 equal or lower in value to R_1 .

7.1.4 Underscale Current

The total current being drawn from the V_{REF} and V_{REG} voltage sources, as well as temperature, affect the XTR106 underscale current value (see Figure 5-8). Consider this when choosing the bridge resistance and excitation voltage, especially for transducers operating over a wide temperature range (see Figure 5-7).

7.1.5 Low-Impedance Bridges

The XTR106 two available excitation voltages (2.5V and 5V) allow the use of a wide variety of bridge values. Bridge impedances as low as $1k\Omega$ can be used without any additional circuitry. Lower impedance bridges can be used with the XTR106 by adding a series resistance to limit excitation current to ≤ 2.5 mA (Figure 7-5). Add resistance to the upper and lower sides of the bridge to keep the bridge output within the 1.1V to 3.5V common-mode input range. Bridge output is reduced so a preamplifier can be needed to reduce offset voltage and drift.







(1) Shown connected to correct positive bridge nonlinearity. For negative bridge nonlinearity, see Figure 6-3.

Figure 7-5. 350Ω Bridge With x50 Preamplifier

7.1.6 Other Sensor Types

The XTR106 can be used with a wide variety of inputs. The high input impedance instrumentation amplifier is versatile and can be configured for differential input voltages from millivolts to a maximum of 2.4V full scale. The linear range of the inputs is from 1.1V to 3.5V, referenced to I_{RET} . The linearization feature of the XTR106 can be used with any sensor whose output is ratiometric with an excitation voltage.

7.1.7 Radio Frequency Interference

The long wire lengths of current loops invite radio frequency (RF) interference. RF interference can be rectified by the sensitive input circuitry of the XTR106 causing errors. These errors generally appears as an unstable output current that varies with the position of loop supply or input wiring.

If the bridge sensor is remotely located, the interference can enter at the input terminals. For integrated transmitter assemblies with short connection to the sensor, the interference more likely comes from the current loop connections.

Bypass capacitors on the input reduce or eliminate this input interference. Figure 6-6 shows to connect these bypass capacitors to the I_{RET} pin. Although the dc voltage at the I_{RET} pin is not equal to 0V (at the loop supply, V_{PS}) this circuit point can be considered the transmitter ground. The 0.01µF capacitor connected between V+ and I_O can help minimize output interference.



7.1.8 Error Analysis

Table 7-1 shows how to calculate the effect various error sources have on circuit accuracy. A sample error calculation for a typical bridge sensor measurement circuit ($5k\Omega$ bridge, $V_{REF} = 5V$, $V_{FS} = 50mV$) is provided. The results reveal the XTR106 excellent accuracy, in this case 1.2% unadjusted. Adjusting gain and offset errors improves circuit accuracy to 0.33%. These are worst-case errors; maximum values were used in the calculations and all errors were assumed to be positive (additive). The XTR106 achieves performance that is difficult to obtain with discrete circuitry and requires less board space.

	Table 7-1. Error	Calculation			
	SAMPLE ERROR CA	LCULATION ⁽¹⁾			
Bridge Impedance (R_B) 5k Ω		Full Scale Input (V _{FS}) 50mV			
Ambient Temperature Range	(ΔT _A) 20°C	Excitation Voltage (V _{REF}) 5V			
Supply Voltage Change (ΔV+)	5V	Common-Mode Voltage Change (ACM)	25mV (= V _{FS} /2)		
			ERROR (ppm	of Full Scale)	
ERROR SOURCE	SAMPLE ERROR EQUATION	ERROR CALCULATION	UNADJ	ADJUST	
INPUT					
Input offset voltage	V _{OS} /V _{FS} · 10 ⁶	200µV/50mV · 10 ⁶	2000	0	
vs common-mode	$CMRR \cdot \Delta CM/V_{FS} \cdot 10^{6}$	$50\mu V/V \cdot 0.025 V/50 mV \cdot 10^{6}$	25	25	
vs power supply	$(V_{OS} vs V+) \cdot (\Delta V+)/V_{FS} \cdot 10^6$	$3\mu V/V \cdot 5V/50mV \cdot 10^{6}$	300	300	
Input bias current	$CMRR \cdot I_B \cdot (R_B/2)/V_{FS} \cdot 10^6$	$50\mu V/V\cdot 25nA\cdot 2.5k\Omega/50mV\cdot 10^{6}$	0.1	0	
Input offset current	$I_{OS} \cdot R_B / V_{FS} \cdot 10^6$	$3nA \cdot 5k\Omega/50mV \cdot 10^{6}$	300	0	
		Total Input Error	2625	325	
EXCITATION					
Voltage reference accuracy	V _{REF} Accuracy (%)/100% · 10 ⁶	0.25%/100% · 10 ⁶	2500	0	
vs supply	$(V_{REF} vs V+) \cdot (\Delta V+) \cdot (V_{FS}/V_{REF})$	20ppm/V · 5V (50mV/5V)	1	1	
		Total Excitation Error	2501	1	
GAIN					
Span	Span Error (%)/100% · 10 ⁶	0.2%/100% · 10 ⁶	2000	0	
Nonlinearity	Nonlinearity (%)/100% · 10 ⁶	0.01%/100% · 10 ⁶	100	100	
		Total Gain Error	2100	100	
OUTPUT					
Zero output	I _{ZERO} – 4mA /16000µA · 10 ⁶	25μΑ/16000μΑ · 10 ⁶	1563	0	
vs supply	(I _{ZERO} vs V+) · (ΔV+)/16000μA · 10 ⁶	0.2μA/V · 5V/16000μA · 10 ₆	62.5	62.5	
		Total Output Error	1626	63	
DRIFT (∆T _A = 20°C)					
Input offset voltage	Drift $\cdot \Delta T_A / (V_{FS}) \cdot 10^6$	1.5μV/°C · 20°C/(50mV) · 10 ⁶	600	600	
Input offset current (typical)	Drift $\cdot \Delta T_A \cdot R_B / (V_{FS}) \cdot 10^6$	$5pA/^{\circ}C \cdot 20^{\circ}C \cdot 5k\Omega/(50mV) \cdot 10^{6}$	10	10	
Voltage reference accuracy		35ppm/°C · 20°C	700	700	
Span		225ppm/°C · 20°C	500	500	
Zero output	Drift $\cdot \Delta T_A / 16000 \mu A \cdot 10^6$	0.9μA/°C · 20°C/16000μA · 10 ⁶	1125	1125	
		Total Drift Error	2936	2936	
NOISE (0.1Hz to 10Hz, typical)				
Input offset voltage	V _n (p-p)/V _{FS} · 10 ⁶	0.6µV/50mV · 10 ⁶	12	12	
Zero output	I _{ZERO} Noise / 16000μA · 10 ⁶	0.035μA/16000μA · 10 ⁶	2.2	2.2	
Thermal R _B noise	$[\sqrt{2} \cdot \sqrt{(R_B/2)}/1k\Omega \cdot 4nV/\sqrt{Hz} \cdot \sqrt{10Hz}]/V_{FS} \cdot 10^{6}$	$\frac{[\sqrt{2}\cdot\sqrt{2.5k\Omega/1k\Omega}\cdot 4nV/\sqrt{Hz}\cdot\sqrt{10Hz}]]}{50mV\cdot 10^6}$	0.6	0.6	
Input current noise	$(i_n\cdot 40.8\cdot \sqrt{2}\cdot R_B/2)/V_{FS}\cdot 10^6$	$\begin{array}{c} (200 fA/\sqrt{Hz} \cdot 40.8 \cdot \sqrt{2} \cdot 2.5 k\Omega)/50 mV \cdot \\ 10^6 \end{array}$	0.6	0.6	
		Total Noise Error	15	15	
			11803	3340	
			1.18%	0.33%	

(1) All errors are minimum and maximum, and referred to input, unless otherwise stated.



7.2 Typical Applications



(1) Lin Polarity shown connected to correct positive bridge nonlinearity. See Figure 6-3 to correct negative bridge nonlinearity.(2) See ISO124 data sheet if isolation is needed.



Figure 7-6. ±12V-Powered Transmitter and Receiver Loop

(1) For burn-out indication.

(2) See ISO124 data sheet if isolation is needed.

Figure 7-7. Thermocouple Low-Offset, Low-Drift Loop Measurement With Diode Cold-Junction Compensation



7.3 Layout

7.4 Layout Guidelines

The XTR106 is typically used with an external transistor (Q_1) to regulate the power dissipation of the 4mA to 20mA loop. This allows the resulting localized self-heating to be distanced from the precision circuitry of the XTR106 and reduces overtemperature drift errors.

The XTR106 can be used without the Q_1 transistor if the application requirements do not lead to violation of the device *Absolute Maximum Requirements*, such as the maximum junction temperature. Calculate the peak power dissipation and multiply by thermal resistance to approximate the associated junction temperature rise. Minimize overheat conditions for reliable long-term operation.

Place supply bypass capacitors close to the package and make connections with low-impedance conductors. Reduce trace lengths for R_G to minimize coupled environmental noise. If the loop power supply is electrically noisy, implement filtering using decoupling capacitors and small resistors or dampening inductors in series with V+.



8 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

8.1 Documentation Support

8.2 Related Documentation

For related documentation see the following:

- · Texas Instruments, Special Function Amplifiers Precision Labs video series on Current Loop Transmitters
- Texas Instruments, Analog Linearization of Resistance Temperature Detectors technical article
- Texas Instruments, A Basic Guide to RTD Measurements application note

8.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

8.4 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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8.5 Trademarks

TI E2E[™] is a trademark of Texas Instruments.

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8.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.7 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision A (November 2003) to Revision B (January 2025)

- Modified end equipments in Applications
- Moved operating and storage temperature parameters from *Electrical Characteristics* to *Absolute Maximum* Ratings
- Moved specified temperature and power-supply parameters from *Electrical Characteristics* to *Recommended* Operating Conditions

Page

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•	Deleted thermal resistance, θ_{JA} parameters in <i>Electrical Characteristics</i> and replaced with detailed thermal model parameters in <i>Thermal Information</i>	.4
•	Added footnote regarding the use of the box method for the voltage references accuracy vs temperature specification in <i>Electrical Characteristics</i>	.5
•	Changed typical V _{REG} accuracy vs temperature specification from ±0.3mV/°C to ±0.5mV/°C in <i>Electrical</i> Characteristics	.5
•	Deleted Input Voltage, Input Current, and Zero Output Current Noise Density vs Frequency plot and replaced with Figure 5-13, Input Voltage Noise Density vs Frequency, and Figure 5-14, Zero Output Current Noise Density vs Frequency.	ל 7
•	Updated Figure 5-20, Reference Voltage Deviation vs Temperature	7
•	Changed description of maximum loop-supply voltage to specified absolute maximum rating in Overvoltage Surge Protection	6
•	Updated suggested transistor part numbers in Figure 7-1, <i>Basic Bridge Measurement Circuit with Linearization</i>	7

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	(3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
XTR106P	Active	Production	PDIP (N) 14	25 TUBE	Yes	Call TI	N/A for Pkg Type	-40 to 85	XTR106P A
XTR106P.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	Call TI	N/A for Pkg Type	-40 to 85	XTR106P A
XTR106PA	Active	Production	PDIP (N) 14	25 TUBE	Yes	Call TI	N/A for Pkg Type	-	XTR106P A
XTR106PA.A	Active	Production	PDIP (N) 14	25 TUBE	Yes	Call TI	N/A for Pkg Type	-40 to 85	XTR106P A
XTR106U/2K5	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	Call TI Nipdau	Level-3-260C-168 HR	-40 to 85	XTR106U
XTR106U/2K5.A	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	XTR106U
XTR106U/2K5.B	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	XTR106U
XTR106UA	Obsolete	Production	SOIC (D) 14	-	-	Call TI	Call TI	-40 to 85	XTR106U A
XTR106UA/2K5	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	Call TI Nipdau	Level-3-260C-168 HR	-40 to 85	(XTR106U, XTR106UA) A
XTR106UA/2K5.A	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	(XTR106U, XTR106UA) A
XTR106UA/2K5.B	Active	Production	SOIC (D) 14	2500 LARGE T&R	Yes	Call TI	Level-3-260C-168 HR	-40 to 85	(XTR106U, XTR106UA) A

⁽¹⁾ Status: For more details on status, see our product life cycle.

(2) Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



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⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
XTR106U/2K5	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
XTR106UA/2K5	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



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PACKAGE MATERIALS INFORMATION

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*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
XTR106U/2K5	SOIC	D	14	2500	353.0	353.0	32.0
XTR106UA/2K5	SOIC	D	14	2500	353.0	353.0	32.0

TEXAS INSTRUMENTS

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23-Jul-2025

TUBE



- B - Alignment groove width

*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	Τ (μm)	B (mm)
XTR106P	N	PDIP	14	25	506	13.97	11230	4.32
XTR106P.A	N	PDIP	14	25	506	13.97	11230	4.32
XTR106PA	N	PDIP	14	25	506	13.97	11230	4.32
XTR106PA.A	N	PDIP	14	25	506	13.97	11230	4.32

D0014A



PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.



D0014A

EXAMPLE BOARD LAYOUT

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



D0014A

EXAMPLE STENCIL DESIGN

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- \triangle The 20 pin end lead shoulder width is a vendor option, either half or full width.



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